

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
-100V	70mΩ@-10V	-14A
	85mΩ@-4.5V	

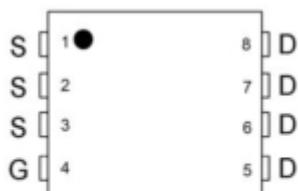
## Feature

- Advanced trench process technology
- Super high dense cell design

## Application

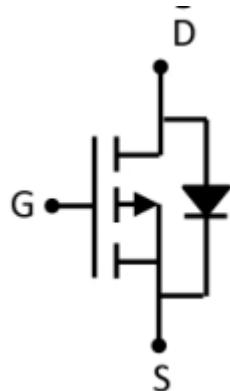
- Motor control
- Power management
- DC/DC convertor

## Package

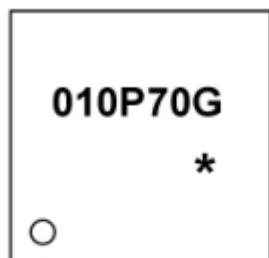


PDFN3×3-8L

## Circuit diagram



## Marking



**010P70G** =Device Code

\* =Month Code

## Absolute maximum ratings

( $T_a=25^\circ\text{C}$  unless otherwise noted)

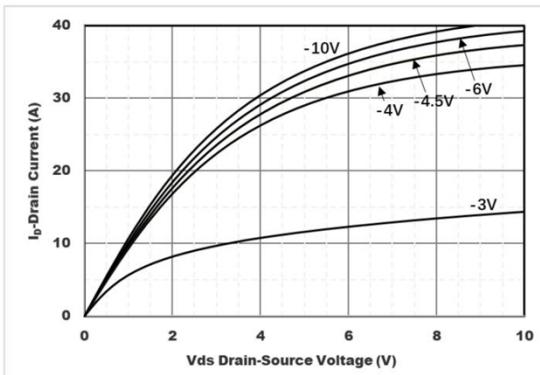
Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	-100	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous ( $T_c=25^\circ\text{C}$ )	$I_D$	-14	W
Drain Current – Pulsed	$I_{DM}$	-56	A
Power Dissipation ( $T_c=25^\circ\text{C}$ )	$P_D$	50	W
Thermal Resistance Junction to Case	$R_{\theta JC}$	2.5	$^\circ\text{C}/\text{W}$
Storage Temperature Range	$T_{STG}$	-55~ +150	$^\circ\text{C}$
Operating Junction Temperature Range	$T_J$	-55~ +150	$^\circ\text{C}$

## Electrical characteristics

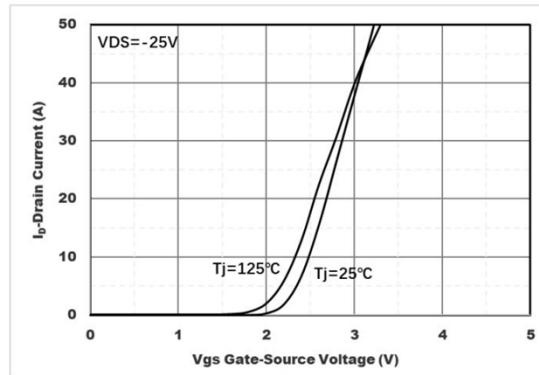
( $T_A=25^\circ\text{C}$ , unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_{\text{D}} = -250\mu\text{A}$	-100			V
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{\text{DS}} = -100\text{V}, V_{\text{GS}} = 0\text{V}$			-1	$\mu\text{A}$
Gate-Source Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 20\text{V}, V_{\text{DS}} = 0\text{V}$			$\pm 100$	$\mu\text{A}$
Gate threshold voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = -250\mu\text{A}$	-1	-1.7	-2.5	V
Static Drain-Source on-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = -10\text{V}, I_{\text{D}} = -10\text{A}$		70	88	$\text{m}\Omega$
		$V_{\text{GS}} = -4.5\text{V}, I_{\text{D}} = -5\text{A}$		85	115	
<b>Dynamic characteristics<sup>4</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = -50\text{V}, V_{\text{GS}} = 0\text{V}, f = 1\text{MHz}$		1050		$\text{pF}$
Output Capacitance	$C_{\text{oss}}$			120		
Reverse Transfer Capacitance	$C_{\text{rss}}$			23		
Total Gate Charge	$Q_g$	$V_{\text{GS}} = -10\text{V}, V_{\text{DS}} = -50\text{V}, I_{\text{D}} = -10\text{A}$		20		$\text{nC}$
Gate-Source Charge	$Q_{\text{gs}}$			4		
Gate-Drain Charge	$Q_{\text{gd}}$			4.4		
Turn-On Delay Time	$T_{\text{d(on)}}$	$V_{\text{GS}} = -10\text{V}, V_{\text{DD}} = -50\text{V}, I_{\text{D}} = -10\text{A}, R_{\text{GEN}} = 9.1\Omega$		15		$\text{nS}$
Rise Time	$T_r$			30		
Turn-Off Delay Time	$T_{\text{d(off)}}$			73		
Fall Time	$T_f$			76		
<b>Drain-Source Diode Characteristics</b>						
Diode forward voltage	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_s = -1\text{A}$			-1.2	V

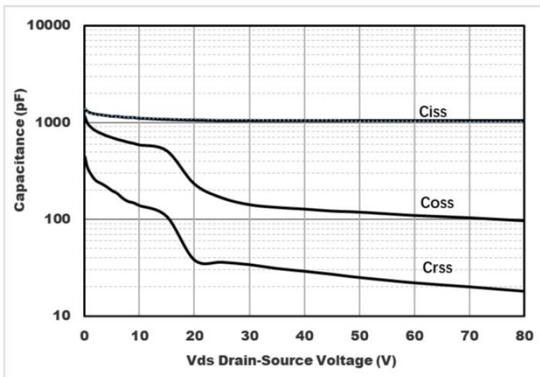
## Typical Characteristics



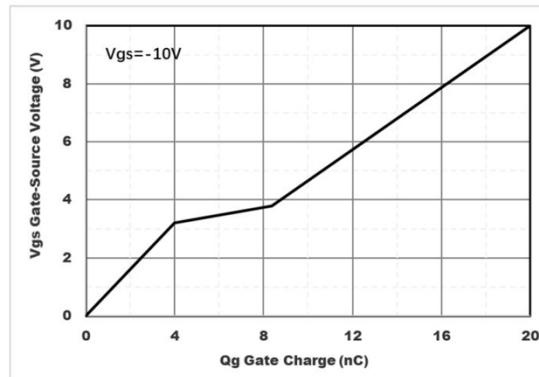
Output Characteristics



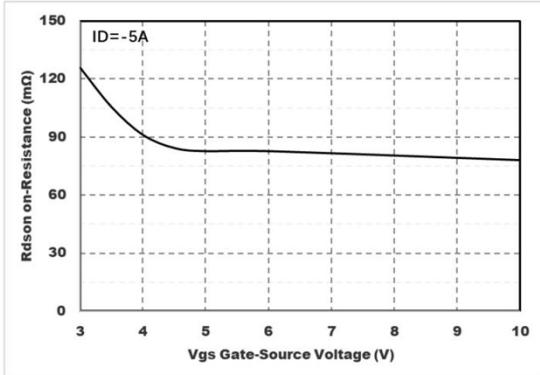
Transfer Characteristics



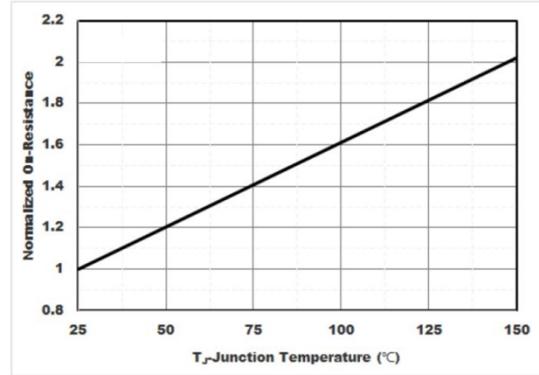
Capacitance Characteristics



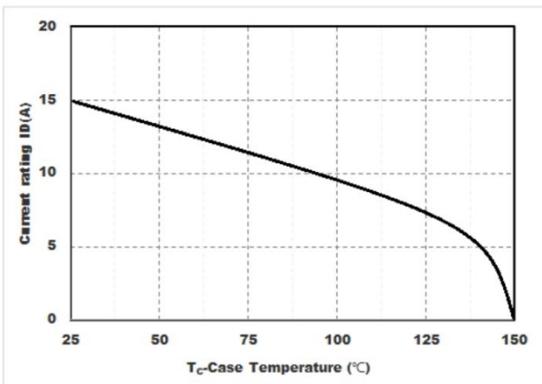
Gate Charge



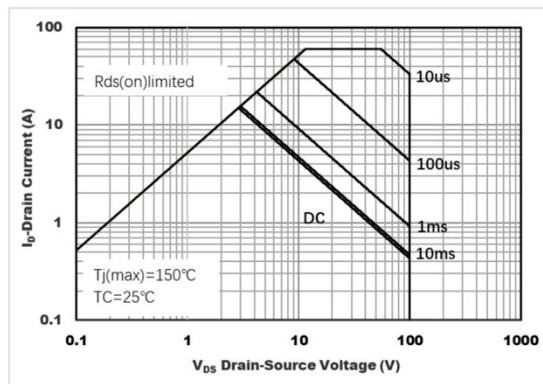
On-Resistance vs. Gate to Source Voltage



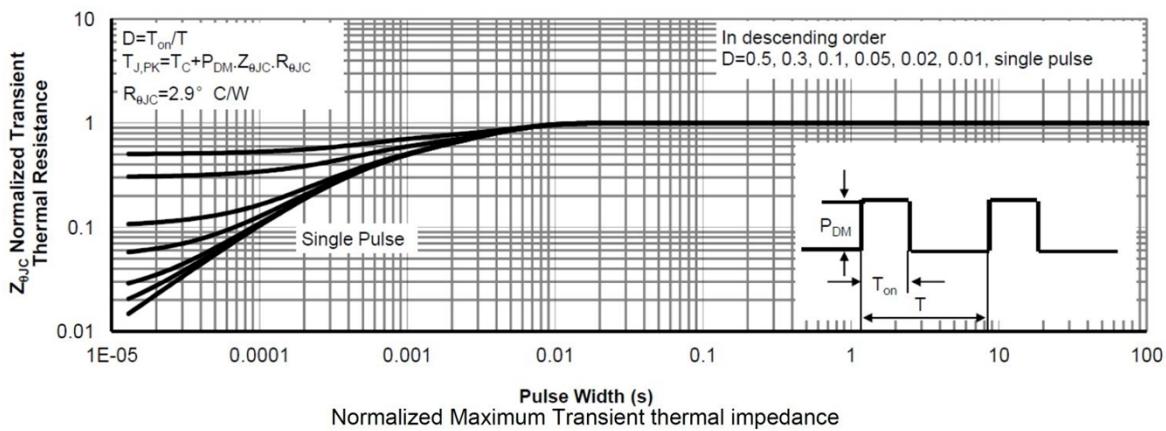
Normalized On-Resistance



Drain current



Safe Operation Area



Normalized Maximum Transient thermal impedance

Single Pulse

D = T<sub>on</sub>/TT<sub>j,PK</sub>= T<sub>c</sub> + P<sub>DM</sub> · Z<sub>θJC</sub> · R<sub>θJC</sub>R<sub>θJC</sub> = 2.9 °C/WIn descending order  
D=0.5, 0.3, 0.1, 0.05, 0.02, 0.01, single pulseT<sub>j(max)</sub>=150°CT<sub>C</sub>=25°C

100

10ms

1ms

100μs

10μs

DC

100

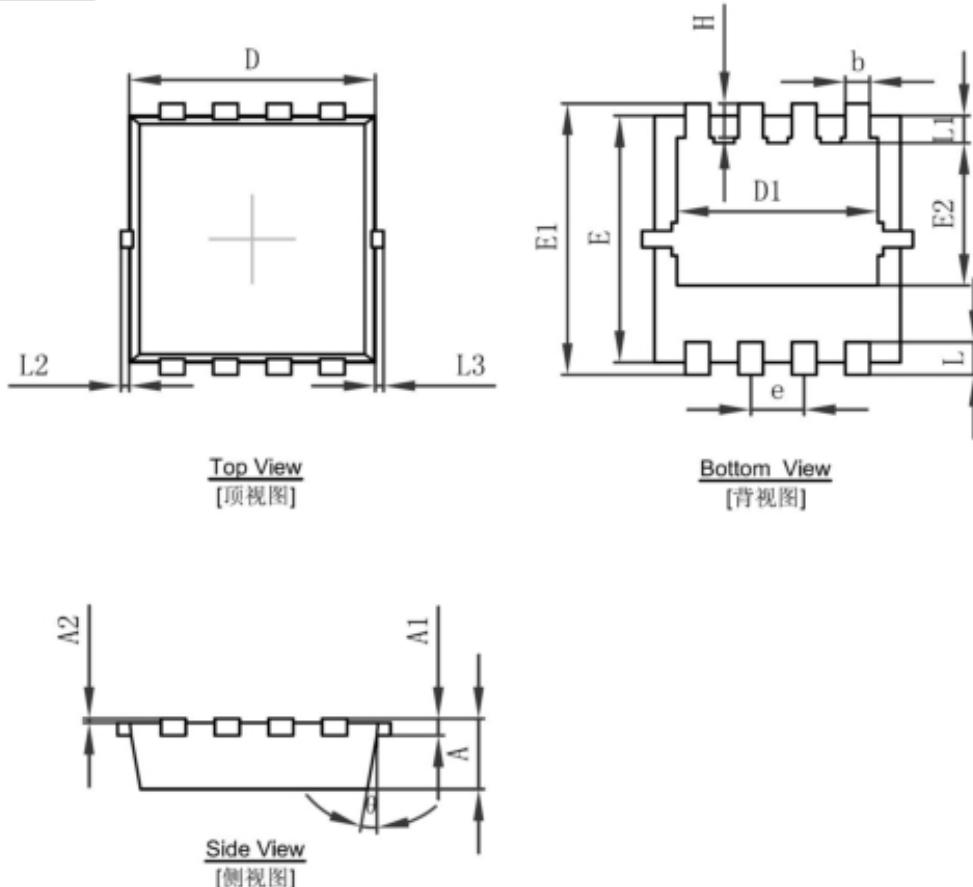
1ms

100μs

10μs

10ms

## PDFN3×3-8L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.650	0.850	0.026	0.033
A1	0.152 REF.			0.006 REF.
A2	0~0.05			0~0.002
D	2.900	3.100	0.114	0.122
D1	2.300	2.600	0.091	0.102
E	2.900	3.100	0.114	0.122
E1	3.150	3.450	0.124	0.136
E2	1.535	1.935	0.060	0.076
b	0.200	0.400	0.008	0.016
e	0.550	0.750	0.022	0.030
L	0.300	0.500	0.012	0.020
L1	0.180	0.480	0.007	0.019
L2	0~0.100			0~0.004
L3	0~0.100			0~0.004
H	0.315	0.515	0.012	0.020
$\theta$	9°	13°	9°	13°